

# TPC8092

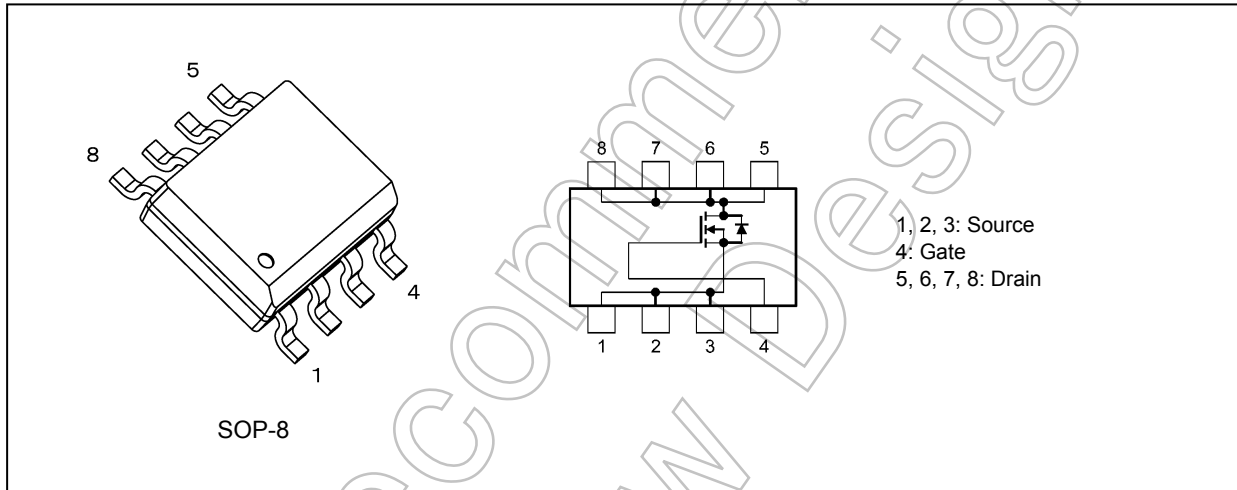
## 1. Applications

- Lithium-Ion Secondary Batteries
- Power Management Switches
- Notebook PCs

## 2. Features

- (1) Small footprint due to a small and thin package
- (2) Low drain-source on-resistance:  $R_{DS(ON)} = 7.6 \text{ m}\Omega$  (typ.) ( $V_{GS} = 10 \text{ V}$ )
- (3) Low leakage current:  $I_{DSS} = 10 \text{ }\mu\text{A}$  (max) ( $V_{DS} = 30 \text{ V}$ )
- (4) Enhancement mode:  $V_{th} = 1.3 \text{ to } 2.3 \text{ V}$  ( $V_{DS} = 10 \text{ V}$ ,  $I_D = 0.2 \text{ mA}$ )

## 3. Packaging and Internal Circuit



## 4. Absolute Maximum Ratings (Note) ( $T_a = 25^\circ\text{C}$ unless otherwise specified)

Characteristics	Symbol	Rating	Unit
Drain-source voltage	$V_{DSS}$	30	V
Gate-source voltage	$V_{GSS}$	$\pm 20$	
Drain current (DC)	(Note 1) $I_D$	15	A
Drain current (pulsed)	(Note 1) $I_{DP}$	60	
Power dissipation	( $t = 10 \text{ s}$ ) (Note 2) $P_D$	1.9	W
Power dissipation	( $t \approx 10 \text{ s}$ ) (Note 3) $P_D$	1.0	W
Single-pulse avalanche energy	(Note 4) $E_{AS}$	70	mJ
Avalanche current	$I_{AR}$	15	A
Channel temperature	$T_{ch}$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Start of commercial production

2010-10

**5. Thermal Characteristics**

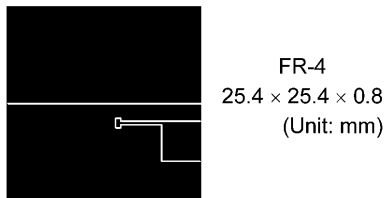
Characteristics			Symbol	Max	Unit
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 2)	$R_{th(ch-a)}$	65.7	°C/W
Channel-to-ambient thermal resistance	(t = 10 s)	(Note 3)	$R_{th(ch-a)}$	125	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

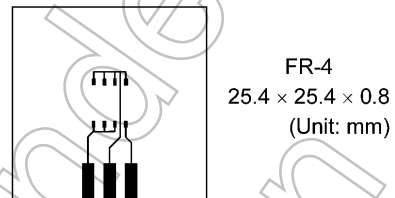
Note 2: Device mounted on a glass-epoxy board (a), Figure 5.1

Note 3: Device mounted on a glass-epoxy board (b), Figure 5.2

Note 4:  $V_{DD} = 24\text{ V}$ ,  $T_{ch} = 25^\circ\text{C}$  (initial),  $L = 0.24\text{ mH}$ ,  $R_G = 1.2\ \Omega$ ,  $I_{AR} = 15\text{ A}$



**Fig. 5.1 Device Mounted on a Glass-Epoxy Board (a)**



**Fig. 5.2 Device Mounted on a Glass-Epoxy Board (b)**

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

Not Recommended for New Design

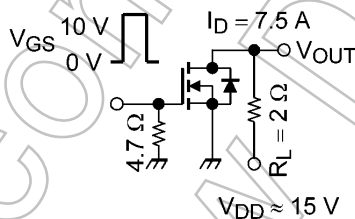
**6. Electrical Characteristics**

**6.1. Static Characteristics ( $T_a = 25^\circ\text{C}$  unless otherwise specified)**

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	$I_{GSS}$	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$	—	—	$\pm 0.1$	$\mu\text{A}$
Drain cut-off current	$I_{DSS}$	$V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}$	—	—	10	
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$	30	—	—	V
	$V_{(BR)DSX}$	$I_D = 10\text{ mA}, V_{GS} = -20\text{ V}$	15	—	—	
Gate threshold voltage	$V_{th}$	$V_{DS} = 10\text{ V}, I_D = 0.2\text{ mA}$	1.3	—	2.3	
Drain-source on-resistance	$R_{DS(ON)}$	$V_{GS} = 4.5\text{ V}, I_D = 7.5\text{ A}$	—	9.2	11.1	$\text{m}\Omega$
		$V_{GS} = 10\text{ V}, I_D = 7.5\text{ A}$	—	7.6	9	

**6.2. Dynamic Characteristics ( $T_a = 25^\circ\text{C}$  unless otherwise specified)**

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Input capacitance	$C_{iss}$	$V_{DS} = 10\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	—	1800	—	$\text{pF}$
Reverse transfer capacitance	$C_{rss}$		—	88	—	
Output capacitance	$C_{oss}$		—	330	—	
Switching time (rise time)	$t_r$	See Figure 6.2.1.	—	2.8	—	ns
Switching time (turn-on time)	$t_{on}$		—	9.6	—	
Switching time (fall time)	$t_f$		—	8.3	—	
Switching time (turn-off time)	$t_{off}$		—	39	—	



Duty  $\leq 1\%$ ,  $t_w = 10\ \mu\text{s}$

**Fig. 6.2.1 Switching Time Test Circuit**

**6.3. Gate Charge Characteristics ( $T_a = 25^\circ\text{C}$  unless otherwise specified)**

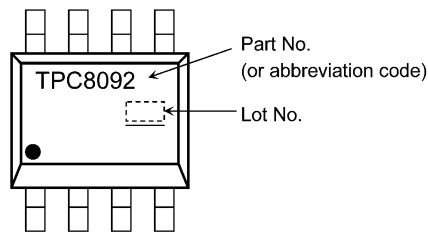
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Total gate charge (gate-source plus gate-drain)	$Q_g$	$V_{DD} \approx 24\text{ V}, V_{GS} = 10\text{ V}, I_D = 15\text{ A}$	—	25	—	nC
Gate-source charge 1	$Q_{gs1}$		—	5.7	—	
Gate-drain charge	$Q_{gd}$		—	2.8	—	

**6.4. Source-Drain Characteristics ( $T_a = 25^\circ\text{C}$  unless otherwise specified)**

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Reverse drain current (pulsed) (Note 5)	$I_{DRP}$	—	—	—	60	A
Diode forward voltage	$V_{DSF}$	$I_{DR} = 15\text{ A}, V_{GS} = 0\text{ V}$	—	—	-1.2	V

Note 5: Ensure that the channel temperature does not exceed  $150^\circ\text{C}$ .

**7. Marking (Note)**

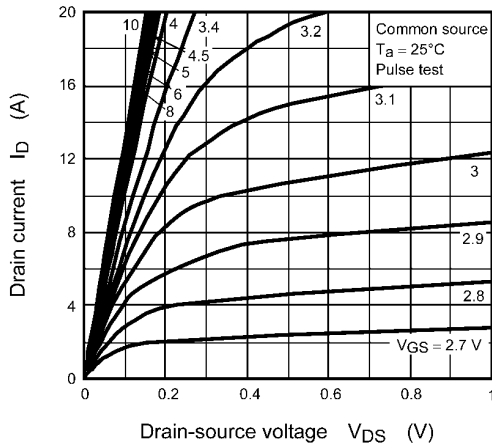


**Fig. 7.1 Marking**

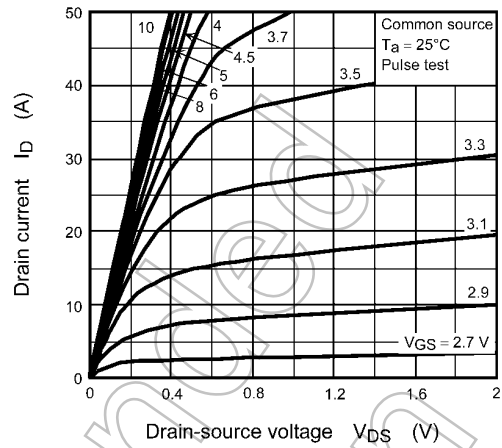
Note: A line under a Lot No. identifies the indication of product Labels.  
 Not underlined: [[Pb]]/INCLUDES > MCV  
 Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]  
 Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.  
 The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

Not Recommended for New Design

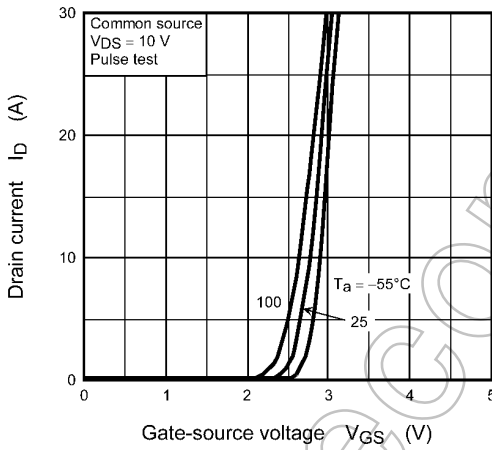
**8. Characteristics Curves (Note)**



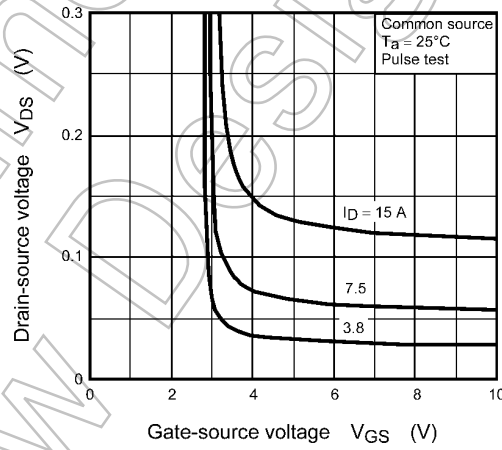
**Fig. 8.1 ID - VDS**



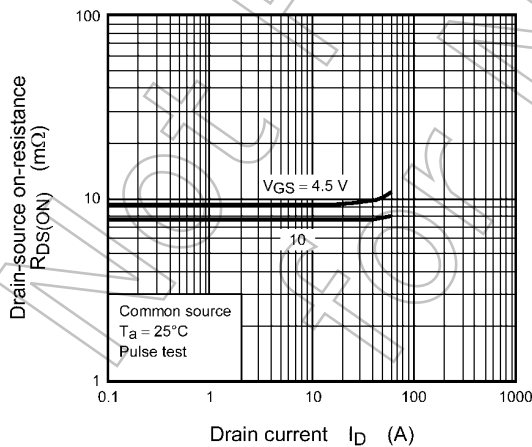
**Fig. 8.2 ID - VDS**



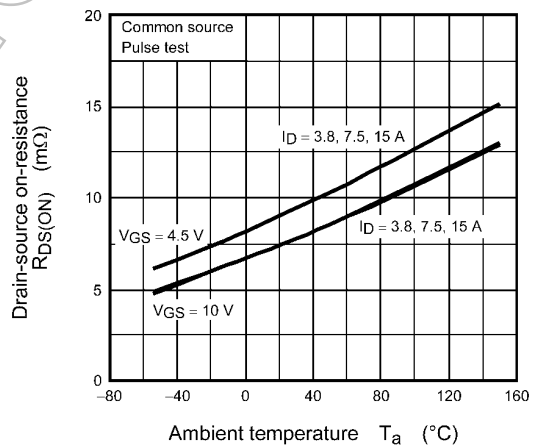
**Fig. 8.3 ID - VGS**



**Fig. 8.4 VDS - VGS**



**Fig. 8.5 RDS(ON) - ID**



**Fig. 8.6 RDS(ON) - Ta**

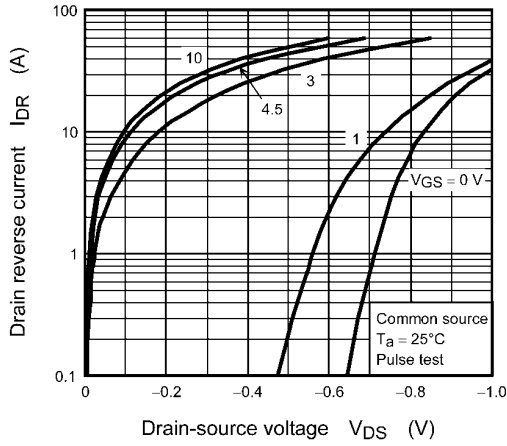


Fig. 8.7  $I_{DR} - V_{DS}$

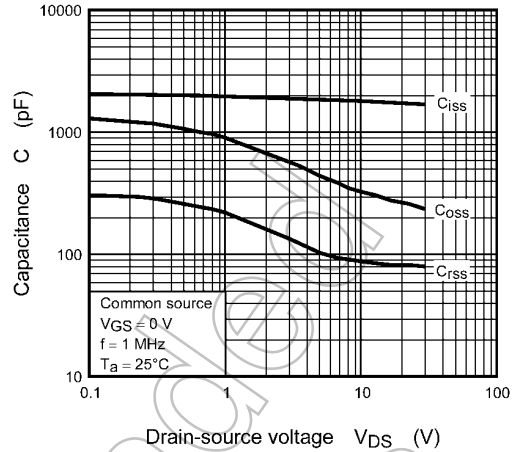


Fig. 8.8 Capacitance -  $V_{DS}$

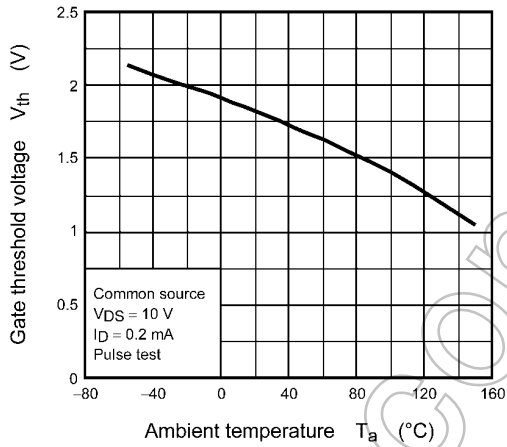


Fig. 8.9  $V_{th} - T_a$

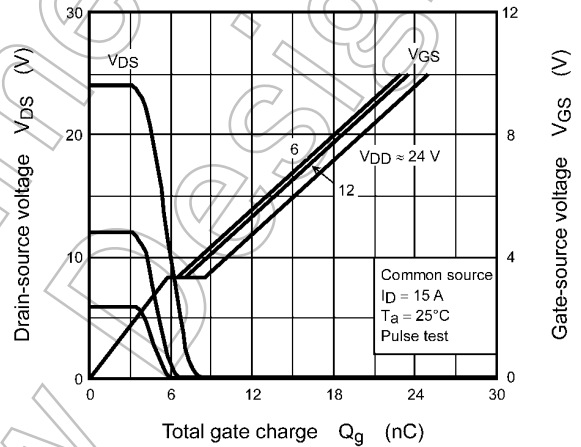


Fig. 8.10 Dynamic Input/Output Characteristics

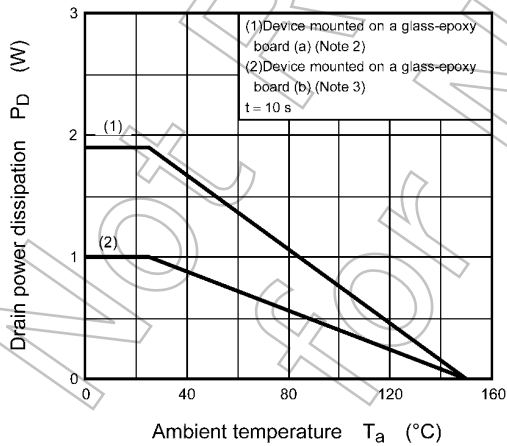
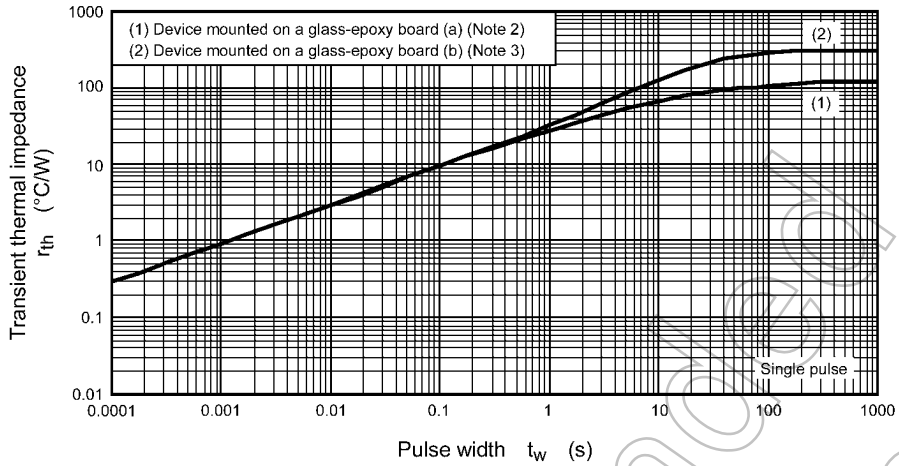
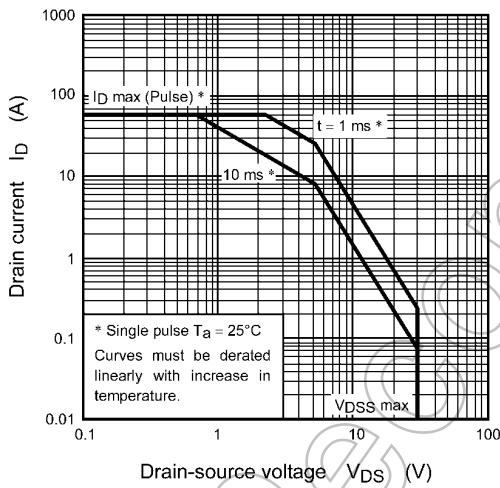


Fig. 8.11  $P_D - T_a$   
(Guaranteed Maximum)



**Fig. 8.12  $r_{th} - t_w$**   
(Guaranteed Maximum)

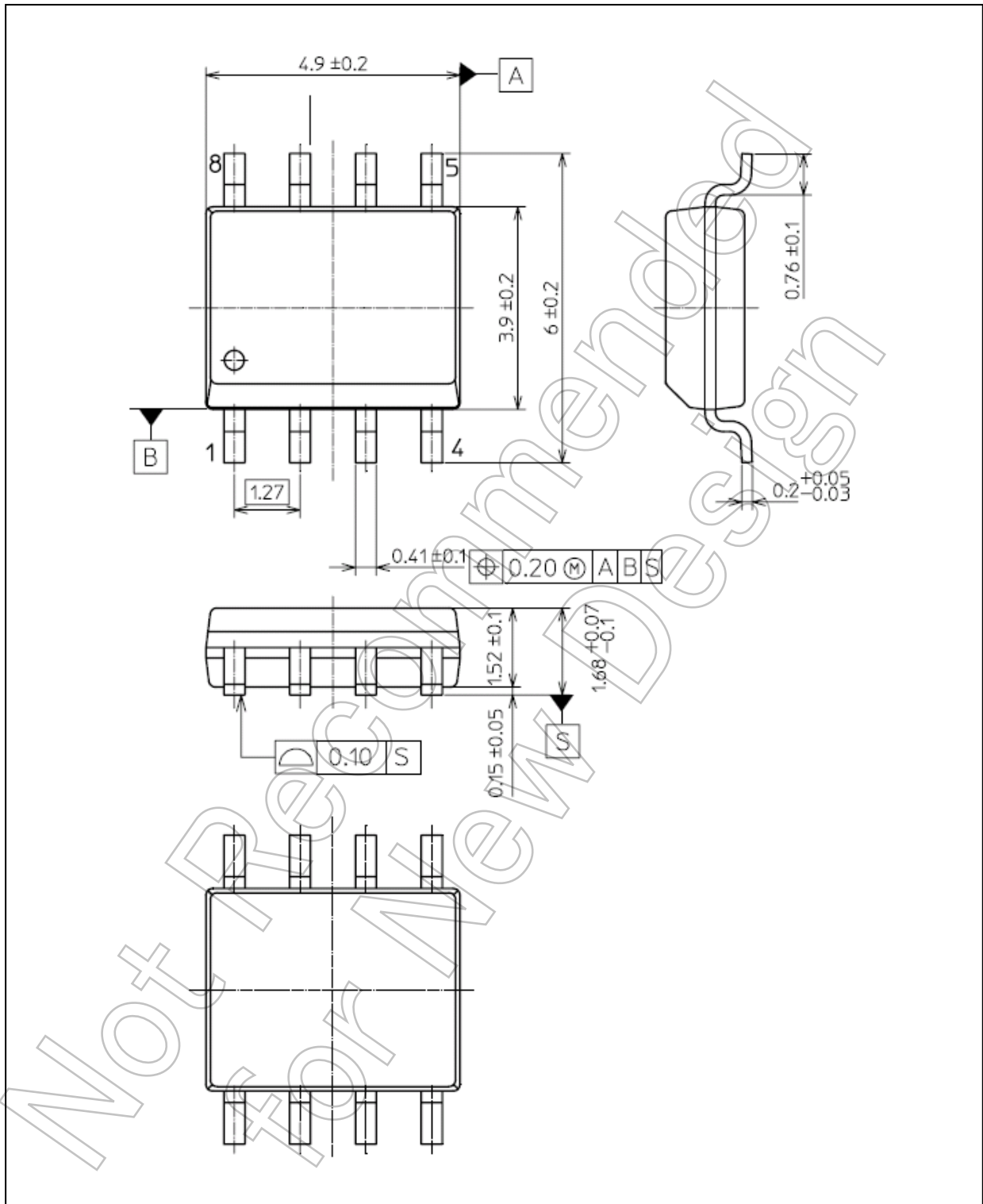


**Fig. 8.13 Safe Operating Area**  
(Guaranteed Maximum)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Package Dimensions

Unit: mm



Weight: 0.085 g (typ.)

Package Name(s)
TOSHIBA: 2-5R1S
Nickname: SOP-8



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